Littelfuse

Thyristors

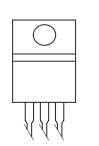
Surface Mount – 400V - 800V > MAC15 Series

MAC15 Series



Pin Out

4 TO-220AB CASE 221A STYLE 4



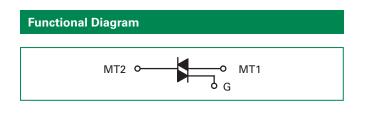
Description

Designed primarily for full-wave ac control applications, such as solid-state relays, motor controls, heating controls and power supplies; or wherever full-wave silicon gate controlled solid-state devices are needed. Triac type thyristors switch from a blocking to a conducting state for either polarity of applied main terminal voltage with positive or negative gate triggering.

Po

Features

- Blocking Voltage to 800 V
- All Diffused and Glass Passivated Junctions for Greater Parameter Uniformity and Stability
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Gate Triggering Guaranteed in Three Modes (MAC15 Series) or Four Modes (MAC15A Series)
- These Devices are Pb-Free and are RoHS Compliant



Additional Information







Samples



Surface Mount – 400V - 800V > MAC15 Series

Maximum Ratings ($T_{J} = 25^{\circ}C$ unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) (Gate Open, Sine Wave 50 to 60 Hz, T _J = 25° to 100°C) MAC15A6G MAC15–8G, MAC15A8G MAC15–10G, MAC15A10G	V _{drm} , V _{rrm}	400 600 800	V
On-State RMS Current (Full Cycle Sine Wave, 50 to 60 Hz, $T_c = 90^{\circ}$ C)	I _{T (RMS)}	15	A
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, $T_{_J}$ = 125°C) Preceded and Followed by Rated Current	I _{TSM}	150	A
Peak Gate Voltage (Pulse Width ::: 1.0 µsec; TC = 90°C)	V _{GM}	10	V
Circuit Fusing Consideration (t = 8.3 ms)	l²t	93	A ² sec
Peak Gate Power ($T_c = +80^{\circ}C$, Pulse Width = 1.0 µs)	P _{gm}	20	W
Peak Gate Current (Pulse Width ::: 1.0 µsec; TC = 90°C)	I _{GM}	2.0	А
Average Gate Power (t = 8.3 ms, $T_c = 80^{\circ}$ C)	P _{G (AV)}	0.5	W
Operating Junction Temperature Range	T,	-40 to +125	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Thermal Characteristics Rating Symbol Value Unit Thermal Resistance, Junction-to-Case (AC) R_{8JC} 2.0 °C/W Junction-to-Ambient R_{8JA} 62.5 °C/W Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds T 260 °C



Surface Mount - 400V - 800V > MAC15 Series

Electrical Characteristics - **OFF** ($T_1 = 25^{\circ}C$ unless otherwise noted ; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Blocking Current	$T_{J} = 25^{\circ}C$	I _{drm} ,	-	-	1.0	μA
$(V_{D} = V_{DRM} = V_{RRM}; Gate Open)$	T _J = 125°C	I _{RRM}	-	-	2.0	mA

Electrical Characteristics - **ON** ($T_J = 25^{\circ}$ C unless otherwise noted; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak On–State Voltage (Note 2) ($I_{TM} = \pm 21$ A Peak)	Peak On-State Voltage (Note 2) ($I_{TM} = \pm 21$ A Peak)			1.3	1.6	V
	MT2(+), G(+)		_	_	50	
Gate Trigger Current (Continuous dc)	MT2(+), G(-)		-	-	50	
$(V_{_{D}} = 12 \text{ V}, \text{ R}_{_{L}} = 100 \Omega)$	MT2(-), G(-)	GT	-	-	50	mA
"A" SUFFIX ONLY	MT2(), G(+)		-	-	75	
	MT2(+), G(+)		0.5	0.62	1.3	
Gate Trigger Voltage (Continuous dc)	MT2(+), G(-)		0.5	0.57	1.3	
$(V_{_{D}} = 12 \text{ V}, \text{ R}_{_{L}} = 100 \Omega)$	MT2(-), G(-)	- V _{gt}	0.5	0.65	1.3	V
"A" SUFFIX ONLY	MT2(), G(+)		0.5	0.74	1.3	
	MT2(+), G(+)		0.2	-	-	
Gate Non-Trigger Voltage (T ₁ = 125°C)	MT2(+), G(-)		0.2	-	-	
$(V_{\rm D} = 12 \text{ V}, \text{ R}_{\rm L} = 100 \Omega)$	MT2(-), G(-)	- V _{gd}	0.2	-	_	V
"A" SUFFIX ONLY	MT2(), G(+)		0.2	_	_	
Holding Current ($V_{p} = 12 V_{dc}$, Gate Open, Initiating Current = ±200 mA))		I _H	-	6.0	40	mA

2. Indicates Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%.

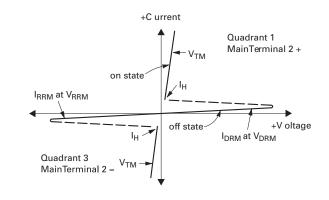
Dynamic Characteristics						
Characteristic	Symbol	Min	Тур	Max	Unit	
Critical Rate of Rise of Commutation Voltage ($V_D = Rated V_{DRM}$, $I_{TM} = 21 A$, Commutating di/dt = 7.6 A/ms, Gate Unenergized, TC = 80°C)	dV/dt	_	5.0	-	V/µs	



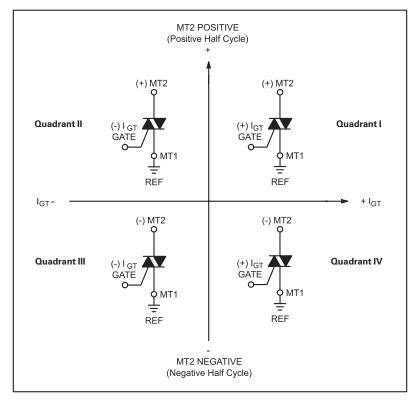
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Voltage Current Characteristic of SCR

Symbol	Parameter
V _{drm}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current



Quadrant Definitions for a Triac



All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used.



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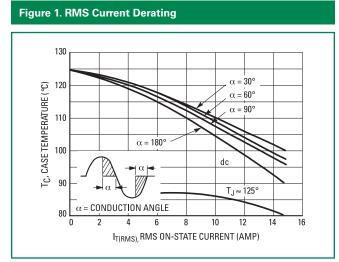


Figure 3. Typical Gate Trigger Voltage

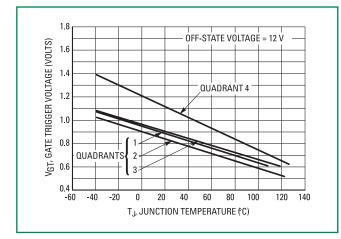


Figure 2. On-State Power Dissipation

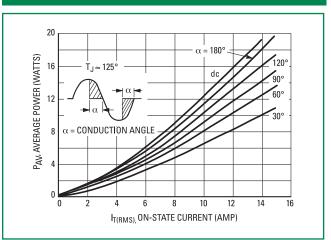
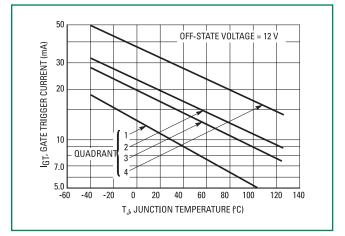


Figure 4. Typical Gate Trigger Current





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Figure 5. On–State Characteristics

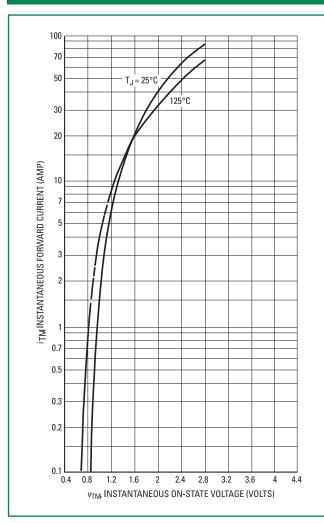


Figure 6. Typical Holding Current

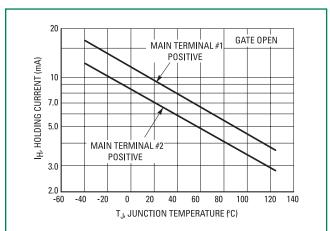


Figure 7. Maximum Non–Repetitive Surge Current

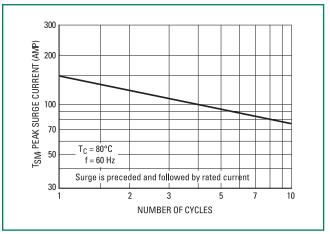
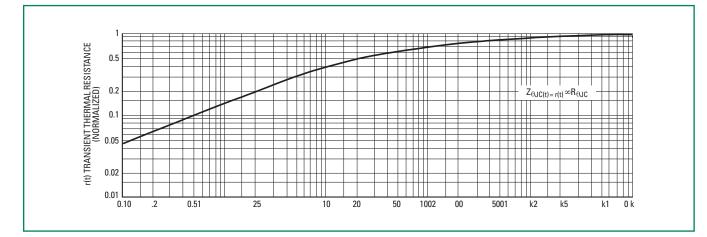


Figure 8. Thermal Response





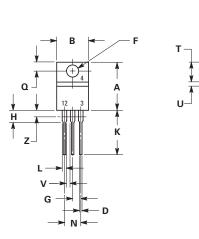
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-T- SEATING PLANE

S

R

Dimensions



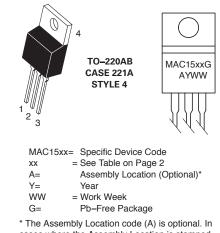
	Inc	nes	Millim	neters
Dim	Min	Max	Min	Max
А	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.014	0.022	0.36	0.55
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z		0.080		2.04

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

Part Marking System



cases where the Assembly Location is stamped on the package the assembly code may be blank.

Pin Assignment	
1	Main Terminal 1
2	Main Terminal 2
3	Gate
4	Main Terminal 2

Ordering Information

Device	Device Marking	Package	Shipping
MAC15-8G	MAC15-8		
MAC15-10G	MAC1510		
MAC15A6G	MAC15A6	TO-220AB (Pb-Free)	500 Units Bulk
MAC15A8G	MAC15A8		
MAC15A10G	MAC15A10		

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